

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

Beaman et al.

Serial No.: 09/382,834

Filed: August 25, 1999

For: **HIGH DENSITY INTEGRATED CIRCUIT APPARATUS,
TEST PROBE AND METHODS OF USE THEREOF**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Date: December 3, 2003

Group Art Unit: 2829

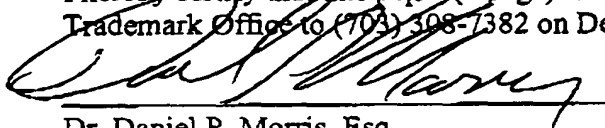
Examiner: V. P. Nguyen

Docket No.: YO993-028BX

Sir:

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this paper (1 page) is being facsimile transmitted to the U.S. Patent and Trademark Office to (703) 308-7382 on December 3, 2003.


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Letter

Applicants note that the claims of the present application, in particular claims 29-52, appear to be substantially similar to the Claims of US patent 5,806,181. Please charge deposit account 09-0468 any fee to enter this paper and any previously submitted paper for the above identified application.


Respectfully submitted,

By: _____

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